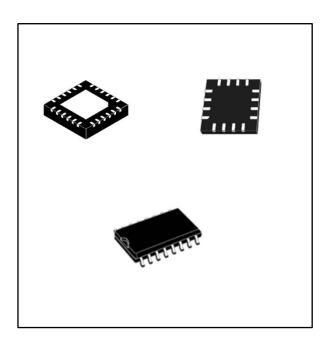
# **STUSB4710**



# Autonomous USB PD controller with integrated discharge path

Datasheet - production data



#### **Features**

- USB power delivery (PD) controller
- Type-C attach and cable orientation detection
- Single role: provider DFP
- Full hardware solution no software
- I<sup>2</sup>C interface (optional connection to MCU)
- Support all USB PD profiles: up to 5 power data objects (PDO)
- Configurable startup profiles
- Integrated V<sub>BUS</sub> voltage monitoring
- Internal and/or external V<sub>BUS</sub> discharge path
- Short -to-V<sub>BUS</sub> protections on CC pins (22 V) and V<sub>BUS</sub> pins (28 V)

- Wide power supply input:
  - V<sub>DD</sub> = [4.1 V; 22 V]
- Temperature range: -40 °C up to 105 °C
- Fully compatible with:
  - USB Type-C<sup>™</sup> rev 1.2
  - USB PD rev 2.0

## **Applications**

- AC adapters and power supplies for: computer, consumer or portable consumer applications
- Smart plugs and wall adapters
- Power hubs and docking stations
- Displays
- Any Type-C source device

### **Description**

The STUSB4710 is a new family of USB power delivery controllers communicating over Type-C™ configuration channel pins (CC) to negotiate a given amount of power to be sourced to an inquiring consumer device.

The STUSB4710 addresses provider/DFP devices such as notebooks, tablets and AC adapters. The device can handle any connections to a UFP or DRP without any MCU attachment support, from device attachment to power negotiation, including V<sub>BUS</sub> discharge and protections.

Table 1: Device summary table

Order code	Description	Package	Marking
STUSB4710QTR		QFN-24L EP (4x4 mm)	
STUSB4710Q1TR	Autonomous USB PD controller (provider)	QFN16 (3x3 mm)	4710
STUSB4710DTR		SO-16	

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## 1 Functional description

The STUSB4710 is an autonomous USB power delivery controller optimized as a provider. It offers an open drain GPIO interface to make direct interconnection with a power regulation stage.

The STUSB4710 offers the benefits of a full hardware USB PD stack allowing robust and safe USB PD negotiation in line with USB PD standard. The STUSB4710 is ideal for provider applications in which digital or software intelligence is limited or missing.

The STUSB4710 main functions are:

- Detect the connection between two USB ports (attach detection)
- Establish a valid host to device connection
- Discover and configure V<sub>BUS</sub>: Type-C low, medium or high current mode
- Resolve cable orientation
- Negotiate a USB power delivery contract with a PD capable device
- Configure the power source accordingly
- Monitor V<sub>BUS</sub>, manage transitions, handle protections and ensure user and device safety

Additionally, the STUSB4710 offers 5 customizable power data objects (PDOs), 5 general purpose I/Os, an integrated discharge path, and is natively robust to high voltage peaks.

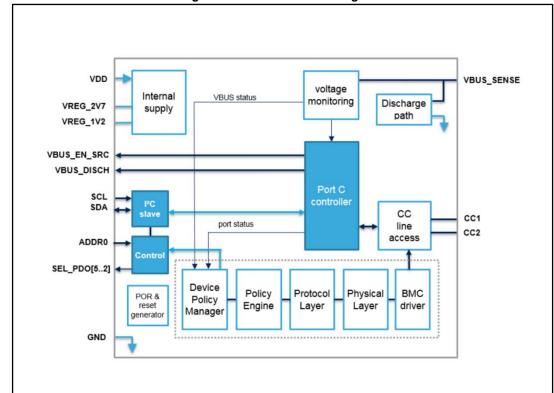


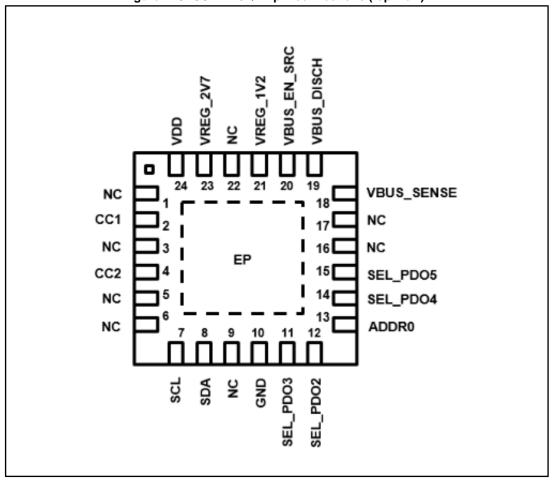
Figure 1: Functional block diagram

STUSB4710 Inputs/outputs

# 2 Inputs/outputs

# 2.1 Pinout

Figure 2: STUSB4710QTR pin connections (top view)

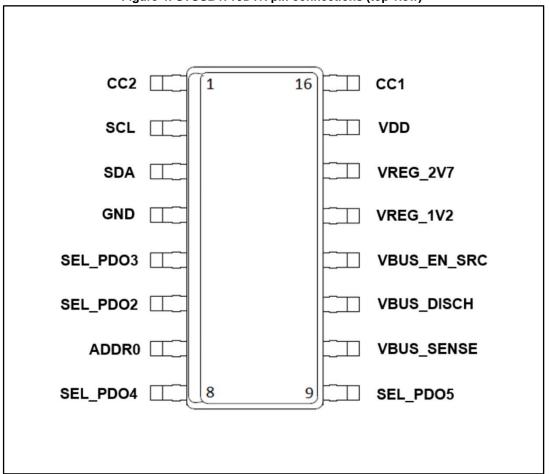


Inputs/outputs STUSB4710

Figure 3: STUSB4710Q1TR pin connections (top view) 16 15 13 14 VDD 12 VBUS\_SENSE CC1 11 SEL\_PDO5 CC2 10 C SEL\_PDO4 SCL ADDR0 9 **C** 7 SDA GND SEL\_PD03

STUSB4710 Inputs/outputs

Figure 4: STUSB4710DTR pin connections (top view)



Inputs/outputs STUSB4710

# 2.2 Pin list

**Table 2: Pin functions list** 

Name Type		Description	Connection
CC1	20 V analog IO	Configuration channel 1	Type-C receptacle A5
CC2	20 V analog IO	Configuration channel 2	Type-C receptacle B5
SCL	DI	I <sup>2</sup> C clock	To I <sup>2</sup> C master – Ext. pull-up
SDA	DI/OD	I <sup>2</sup> C data input/output – active low open drain	To I <sup>2</sup> C master – Ext. pull-up
GND	Power	Ground	
SEL_PDO3	OD	PD03 select flag	
SEL_PDO2	OD	PD02 select flag	
ADDR0	Analog	I2C address 0 bit	
SEL_PDO4	OD	PD04 select flag	
SEL_PDO5	OD	PD05 select flag	
VBUS_SENSE	20 V AI	V <sub>BUS</sub> voltage monitoring and discharge path	From V <sub>BUS</sub>
VBUS_DISCH	Output	External discharge control signal	
VBUS_EN_SRC	20 V OD	V <sub>BUS</sub> source power path enable – active low open drain	To switch or power system  – Ext. pull-up
VREG_1V2	Analog	1.2 V regulator output	1μF typ decoupling capacitor
VREG_2V7	Analog	2.7 V regulator output	1μF typ decoupling capacitor
VDD	20 V power	Main power supply (USB power line)	From V <sub>BUS</sub> (system side)
EP	Exposed pad	Exposed pad is connected to ground	To Ground

Table 3: Legend

	i dino or Logona
Туре	Description
D	Digital
Α	Analog
0	Output pad
I	Input pad
Ю	Bidirectional pad
OD	Open drain output
PD	Pull-down
PU	Pull-up
PWR	Power supply
GND	Ground

STUSB4710 Inputs/outputs

### 2.3 Pin description

#### 2.3.1 CC1 / CC2

CC1 and CC2 are the configuration channel pins used for connection and attachment detection, plug orientation determination and system configuration management across USB Type-C cable. CC1/CC2 are HiZ during reset.

### 2.3.2 I<sup>2</sup>C interface pins

Table 4: I2C interface pins list

Name	e Description		
SCL	I <sup>2</sup> C clock – need external pull-up		
SDA	I <sup>2</sup> C data – need external pull-up		

#### 2.3.3 VBUS\_SENSE

This input pin is used to sense  $V_{\text{BUS}}$  presence, monitor  $V_{\text{BUS}}$  voltage and discharge  $V_{\text{BUS}}$  on USB Type-C receptacle side.

#### 2.3.4 VBUS\_EN\_SRC

In Source power role, this pin allows enabling of the outgoing  $V_{\text{BUS}}$  power when the connection to a Sink is established and  $V_{\text{BUS}}$  is in the valid operating range. The open drain output allows to drive directly a PMOS transistor. The logic value of the pin is also advertised in a dedicated  $I^2C$  register bit.

#### 2.3.5 V<sub>DD</sub>

 $V_{\text{DD}}$  is the main power supply for applications powered by  $V_{\text{BUS}}$ .

This pin can be used to sense the voltage level of the main power supply providing  $V_{\text{BUS}}$ . It allows to consider independently UVLO and OVLO voltage thresholds on VDD pin as additional conditions to enable the  $V_{\text{BUS}}$  power path through VBUS\_EN\_SRC pin.

#### 2.3.6 GND

Ground.

#### 2.3.7 ADDR0

At startup, this pin is latched to set I<sup>2</sup>C device address 0 bit.

#### 2.3.8 VREG2V7

This pin is used only for external decoupling of 2.7 V internal regulator.

Recommended decoupling capacitor: 1 µF typ. (0.5 µF min; 10 µF max).

This pin must not be used to supply any external component.

#### 2.3.9 VBUS\_DISCH

Control signal for external VBUS\_DISCH path.

Inputs/outputs STUSB4710

# 2.3.10 SEL\_PDO [5:2]

These 4 output signals are asserted (active low) respectively when PDO2, PDO3, PDO4 and PDO5 are selected by the attached sink. These signals are used to pilot the power management unit.

STUSB4710 Block descriptions

## 3 Block descriptions

#### 3.1 CC interface

The STUSB4710 controls the connection to the configuration channel (CC) pins, CC1 and CC2, through two main blocks, the CC lines interface block and the CC control logic block.

The CC lines interface block is used to:

- Configure the termination mode on the CC pins relative to the power mode supported, i.e. pull-up for source power role
- Monitor the CC pin voltage values relative to the attachment detection thresholds
- Protect the CC pins against over voltage

The CC control logic block is used to:

- Execute the Type-C FSM relative to the Type-C power mode supported
- Determine the electrical state for each CC pins relative to the detected thresholds
- Evaluate the conditions relative to the CC pin states and V<sub>BUS</sub> voltage value to transition from one state to another in the Type-C FSM
- Detect and establish a valid source-to-sink connection
- Determine the attached mode: source, accessory
- Determine cable orientation to allow external routing of the USB super speed data
- Manage V<sub>BUS</sub> power capability: USB default, Type-C medium or Type-C high current mode
- Handle hardware faults

The CC control logic block implements the Type-C FSM's corresponding to source power role with accessory support.

#### 3.2 BMC

This block is the physical link between USB PD protocol layer and CC pin. In TX mode, it converts the data into biphase mark coding (BMC), and drives the CC line to correct voltages. In RX mode, it recovers BMC data from the CC line, and converts to baseband signaling for the protocol layer.

### 3.3 Protocol layer

The protocol layer has the responsibility to manage the messages from/to the physical layer. It automatically manages the protocol receive timeouts, the message counter, the retry counter and the GoodCRC messages.

It communicates with the internal policy engine.

### 3.4 Policy engine

The policy engine implements the power negotiation with the connected device according to its source role, it implements all states machine that controls protocol layer forming and scheduling the messages.

The policy engine uses the protocol layer to send/receive messages.

The policy engine interprets the device policy manager's input in order to implement policy for port and directs the protocol layer to send appropriate messages.

Block descriptions STUSB4710

### 3.5 Device policy manager

The device policy manager is managing the power resources.

### 3.6 V<sub>BUS</sub> power path control

#### 3.6.1 V<sub>BUS</sub> monitoring

The  $V_{BUS}$  monitoring block supervises (from the VBUS\_SENSE input pin) the  $V_{BUS}$  voltage on the USB Type-C receptacle side.

This block is used to check that V<sub>BUS</sub> is within a valid voltage range:

- To establish a valid source-to-sink connection according to USB Type-C standard specification
- To enable safely the V<sub>BUS</sub> power path through VBUS\_EN\_SRC pin

It allows detection of unexpected  $V_{\text{BUS}}$  voltage conditions such as undervoltage or overvoltage relative to the valid  $V_{\text{BUS}}$  voltage range. When such conditions occur, the STUSB4710 reacts as follows:

- At attachment, it prevents the source-to-sink connection and the V<sub>BUS</sub> power path assertion
- After attachment, it deactivates the source-to-sink connection and disables the V<sub>BUS</sub> power path. The device goes into error recovery state.

The  $V_{BUS}$  voltage value is automatically adjusted at attachment and at each PDO transition. The monitoring is then disabled during T\_PDO\_transition (default 280 ms changed through NVM programming). Additionally, if a transition occurs to a lower voltage, the discharge path is activated during this time.

The valid  $V_{BUS}$  voltage range is defined from the  $V_{BUS}$  nominal voltage by a high threshold voltage and a low threshold voltage whose minimal values are respectively  $V_{BUS}+5\%$  and  $V_{BUS}-5\%$ . The nominal threshold limits can be shifted by a fraction of  $V_{BUS}$  from +1% to +15% for the high threshold voltage and from -1% to -15% for the low threshold voltage. This means the threshold limits can vary from  $V_{BUS}+5\%$  to  $V_{BUS}+20\%$  for the high limit and from  $V_{BUS}-5\%$  to  $V_{BUS}-20\%$  for the low limit.

The threshold limits are preset by default in the NVM with different shift coefficients (see Section 8.3: "Electrical and timing characteristics"). The threshold limits can be changed independently through NVM programming (see Section 8.3: "Electrical and timing characteristics") and also by software during attachment through the I<sup>2</sup>C interface (see Section 6: "I<sup>2</sup>C register map").

#### 3.6.2 V<sub>BUS</sub> discharge

The monitoring block handles also the internal V<sub>BUS</sub> discharge path connected to the VBUS\_SENSE input pin. The discharge path is activated at detachment, or when the device goes into the error recovery state (see *Section 3.8: "Hardware fault management"*).

The V<sub>BUS</sub> discharge path is enabled by default in the NVM and can be disabled through NVM programming only (see *Section 4: "User-defined startup configuration"*). Discharge time duration (T\_PDO\_transition and T\_Transition to 0 V) are also preset by default in the NVM (see *Section 8.3: "Electrical and timing characteristics"*). The discharge time duration can be changed through NVM programming (see *Section 4: "User-defined startup configuration"*) and also by software through the I<sup>2</sup>C interface (see *Section 6: "I<sup>2</sup>C register map"*).

STUSB4710 Block descriptions

### 3.6.3 V<sub>BUS</sub> power path assertion

The STUSB4710 can control the assertion of the  $V_{\text{BUS}}$  power path on USB Type-C port, directly or indirectly, through VBUS\_EN\_SRC pin.

The following table summarizes the configurations and the conditions that determine the logic value of VBUS EN SRC pin during system operation.

Table 5: Conditions	for VBUS	power p	ath assertion
---------------------	----------	---------	---------------

Pin	Electrical	Operation conditions			Comment
PIN	value	Attached state	V <sub>DD</sub> monitoring	V <sub>BUS</sub> monitoring	Comment
		Attached.SRC	\/DD	Valle within valid voltage range	The signal
VBUS_EN_SRC	0	UnorientedDebug Accessory.SRC	VDD > UVLO if VDD_UVLO enabled and/or VDD < OVLO	V <sub>BUS</sub> within valid voltage range if VBUS _VALID_RANGE enabled	is asserted only if all the valid
		OrientedDebug Accessory.SRC	if VDD_OVLO enabled	or V <sub>BUS</sub> > UVLO if VBUS _VALID_RANGE disabled	operation conditions are met.
HiZ		Any other state	VDD < UVLO if VDD_UVLO enabled and/or VDD > OVLO if VDD_OVLO enabled	V <sub>BUS</sub> is out of valid voltage range if VBUS _VALID_RANGE enabled or V <sub>BUS</sub> < UVLO if VBUS _VALID_RANGE disabled	The signal is de-asserted when at least one non-valid operation condition is met.



Activation of the UVLO and OVLO threshold detections can be done through NVM programming (see Section 4: "User-defined startup configuration") and also by software through the I<sup>2</sup>C interface (see Section 6: "I<sup>2</sup>C register map"). When the UVLO and/or OVLO threshold detection is activated, the VBUS\_EN\_SRC pin is asserted only if the device is attached and the valid threshold conditions on V<sub>DD</sub> are met. Once the VBUS\_EN\_SRC pin is asserted, the V<sub>BUS</sub> monitoring is done on VBUS\_SENSE pin instead of the V<sub>DD</sub> pin.

## 3.7 High voltage protection

The STUSB4710 can be safely used in systems or connected to systems that handle high voltage on the  $V_{BUS}$  power path. The device integrates an internal circuitry on the CC pins that tolerates high voltage and ensures a protection up to 22 V in case of unexpected short circuit with  $V_{BUS}$  or in case of connection to a device supplying high voltage on  $V_{BUS}$ .

## 3.8 Hardware fault management

The STUSB4710 handles hardware fault conditions related to the device itself and the  $V_{\text{BUS}}$  power path during system operation.

When such conditions occur, the circuit goes into a transient error recovery state named ErrorRecovery in the Type-C FSM. When entering in this state, the device de-asserts the VBUS power path by disabling the VBUS\_EN\_SRC pin, and it removes the terminations from the CC pins during several tens of milliseconds. Then, it transitions to the unattached source state.

Block descriptions STUSB4710

The STUSB4710 goes into error recovery state when at least one condition listed below is met:

- If an overtemperature is detected, the "THERMAL\_FAULT"flag is asserted.
- If an internal pull-up voltage on CC pins is below UVLO threshold, the "VPU\_VALID" flag is asserted.
- If an overvoltage is detected on the CC pins, the "VPU\_OVP\_FAULT" flag is asserted.
- If the V<sub>BUS</sub> voltage is out of the valid voltage range during attachment, the "VBUS\_VALID" flag is asserted.
- If an undervoltage is detected on the V<sub>DD</sub> pin during attachment when UVLO detection is enabled, the "VDD UVLO DISABLE" flag is asserted.
- If an overvoltage is detected on the V<sub>DD</sub> pin during attachment when OVLO detection is enabled, the "VDD OVLO DISABLE" flag is asserted.

The I<sup>2</sup>C register bits mentioned above in quotes give either the state of the hardware fault when it occurs or the setting condition to detect the hardware fault.

### 3.9 Accessory mode detection

The STUSB4710 supports the detection of audio accessory mode and debug accessory mode as defined in the USB Type-C standard specification source power role with accessory support.

#### 3.9.1 Audio accessory mode detection

The STUSB4710 detects an audio accessory device when both the CC1 and CC2 pins are pulled down to ground by a Ra resistor from the connected device. The audio accessory detection is advertised through the CC\_ATTACHED\_MODE bits of the I<sup>2</sup>C register CC CONNECTION STATUS.

#### 3.9.2 Debug accessory mode detection

The STUSB4710 detects a connection to a debug and test system (DTS) when it operates either in sink power role or source power role. The debug accessory detection is advertised by the DEBUG1 and DEBUG2 pins as well as through the CC\_ATTACHED\_MODE bits of the I<sup>2</sup>C register CC CONNECTION STATUS.

In source power role, a debug accessory device is detected when both the CC1 and CC2 pins are pulled down to ground by a Rd resistor from the connected device. The orientation detection is performed in two steps as described in the table below. The DEBUG2 pin is asserted to advertise the DTS detection and the A\_B\_SIDE pin indicates the orientation of the connection. The orientation detection is advertised through the TYPEC\_FSM\_STATE bits of the I²C register CC\_OPERATION\_STATUS.

### 4 User-defined startup configuration

#### 4.1 Parameter overview

The STUSB4710 has a set of user-defined parameters that can be customized by NVM reprogramming and/or by software through I<sup>2</sup>C interface. It allows changing the preset configuration of USB Type-C and PD interface and to define a new configuration to meet specific customer requirements addressing various applications, use cases or specific implementations.

The NVM re-programming overrides the initial default setting to define a new default setting that will be used at power-up or after a reset. The default value is copied at power-up, or after a reset, from the embedded NVM into dedicated I<sup>2</sup>C register bits. The NVM re-programming is possible few times with a customer password.

Feature	Parameter	Value	Default
DD04	Voltage	5 V	5 V
PDO1	Current	Configurable – defined by PDO1_I [3:0]	3 A
DDOO	Voltage	Configurable – defined by PDO2_V [1:0]	9 V
PDO2 Current		Configurable – defined by PDO2_I [3:0]	3 A
PDO3	Voltage	Configurable – defined by PDO3_V [1:0]	12 V
PD03	Current	Configurable – defined by PDO3_I [3:0]	3 A
DDO4	Voltage	Configurable – defined by PDO4_V [1:0]	15 V
PDO4	Current	Configurable – defined by PDO4_I [3:0]	3 A
DDOE	Voltage	Configurable – defined by PDO5_V [1:0]	20 V
PDO5	Current	Configurable – defined by PDO5_I [3:0]	2.25 A

Table 6: PDO configurations in NVM

When a default value is changed during system boot by software, the new settings apply as long as STUSB4710 is operating and until it is changed again. But after power-off and power-up, or after a hardware reset, STUSB4710 takes back default values defined in the NVM.

## 4.2 PDO – voltage configuration in NVM

PDO2\_V [1:0], PDO3\_V [1:0], PDO4\_V [1:0] and PDO5\_V [1:0] can be configured with the following values:

 Value
 Configuration

 2b00
 9 V

 2b01
 15 V

 2b10
 PDO\_FLEX\_V1

 2b11
 PDO\_FLEX\_V2

**Table 7: PDO NVM voltage configuration** 

PDO\_FLEX\_V1 and PDO\_FLEX\_V2 are defined in a specific 10-bit register, value being expressed in 50 mV units.



For instance:

- PDO\_FLEX\_V1 = 10b0100100010 → 14.5 V
- PDO\_FLEX\_V2 =  $10b0110000110 \rightarrow 19.5 \text{ V}$

### 4.3 PDO – current configuration in NVM

PDO1\_I [3:0], PDO2\_I [3:0], PDO3\_I [3:0], PDO4\_I [3:0] and PDO5\_I [3:0] can be configured with the following fixed values:

Table 8: PDO NVM current configuration

Value	Configuration
4b0000	PDO_FLEX_I
4b0001	1.50 A
4b0010	1.75 A
4b0011	2.00 A
4b0100	2.25 A
4b0101	2.50 A
4b0110	2.75 A
4b0111	3.00 A
4b1000	3.25 A
4b1001	3.50 A
4b1010	3.75 A
4b1011	4.00 A
4b1100	4.25 A
4b1101	4.50 A
4b1110	4.75 A
4b1111	5.00 A

PDO\_FLEX\_I is defined in a specific 10-bit register, value being expressed in 10 mA units. For instance:

• PDO FLEX I = 10b0011100001 → 2.25 A

## 4.4 Monitoring configuration in NVM

- T\_PDO\_Transition can be configured from 20 to 300 ms by increments of 20 ms (0 is not recommended). Default value is 240 ms.
- T\_Transition\_to\_0V can be configured from 84 to 1260 ms by increments of 84 ms (0 is not recommended). Default value is 168 ms.
- Vshift\_High can be configured from (5 to 20%). Default value ranges from 8% to 12%.
- Vshift Low can be configured from (5 to 20%). Default value is 10% for all PDO.

### 4.5 Discharge configuration in NVM

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Both internal and external discharge paths are enabled by default. VBUS\_DISCH control pin is configured to drive a PMOS by default (active low).

STUSB4710 I<sup>2</sup>C interface

### 5 I<sup>2</sup>C interface

### 5.1 Read and write operations

The I<sup>2</sup>C interface is used to configure, control and read the status of the device. It is compatible with the Philips I<sup>2</sup>C Bus® (version 2.1). The I<sup>2</sup>C is a slave serial interface based on two signals:

- SCL serial clock line: input clock used to shift data
- SDA serial data line: input/output bidirectional data transfers

A filter rejects the potential spikes on the bus data line to preserve data integrity.

The bidirectional data line supports transfers up to 400 Kbit/s (fast mode). The data are shifted to and from the chip on the SDA line, MSB first.

The first bit must be high (START) followed by the 7-bit device address and the read/write control bit.

Two 7-bit device addresses are available for STUSB4710 thanks to external programming of DevADDR0, through ADDR0, pin setting. It allows to connect two STUSB4710 devices on the same I<sup>2</sup>C bus.

ADDR are not available for all configurations.

Device address format:

Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
DevADDR6	DevADDR5	DevADDR4	DevADDR3	DevADDR2	DevADDR1	DevADDR0	R/W
0	1	0	1	0	0	ADDR0	0/1

#### Register address format:

Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
RegADDR7	RegADDR6	RegADDR5	RegADDR4	RegADDR3	RegADDR2	RegADDR1	RegADDR0

#### Register data format:

Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
DATA7	DATA6	DATA5	DATA4	DATA3	DATA2	DATA1	DATA0

I<sup>2</sup>C interface STUSB4710

Figure 5: Read operation

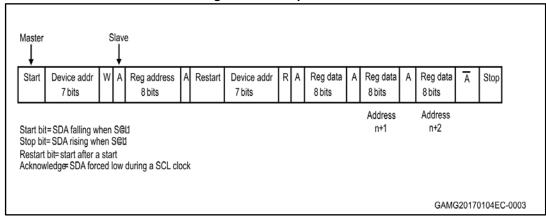
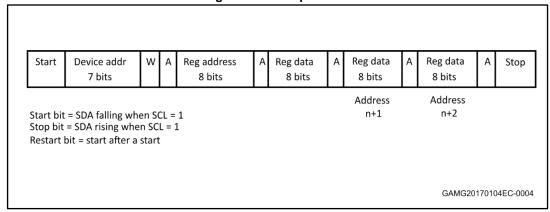


Figure 6: Write operation



# 5.2 Timing specifications

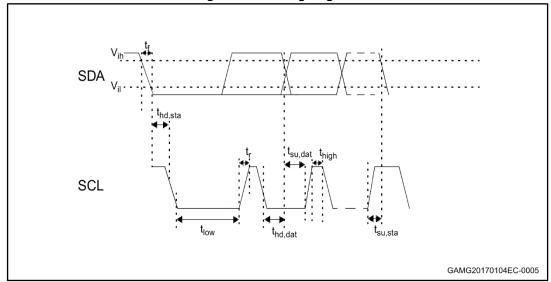
The device uses a standard slave I<sup>2</sup>C channel at speed up to 400 kHz.

Table 9: I<sup>2</sup>C timing parameters - VDD = 5 V

Symbol	Parameter	Min	Тур	Max	Unit
F <sub>scl</sub>	SCL clock frequency	0	-	400	kHz
t <sub>hd,sta</sub>	Hold time (repeated) START condition	0.6	-	-	μs
t <sub>low</sub>	LOW period of the SCL clock	1.3	-	-	μs
thigh	HIGH period of the SCL clock	0.6	-	-	μs
t <sub>su,dat</sub>	Setup time for repeated START condition	0.6	-	-	μs
t <sub>hd,dat</sub>	Data hold time	0.04	-	0.9	μs
t <sub>su,dat</sub>	Data setup time	100	-	-	μs
t <sub>r</sub>	Rise time of both SDA and SCL signals	20 + 0.1 C <sub>b</sub>	-	300	ns
t <sub>f</sub>	Fall time of both SDA and SCL signals	20 + 0.1 C <sub>b</sub>	-	300	ns
t <sub>su,sto</sub>	Setup time for STOP condition	0.6	-	-	μs
t <sub>buf</sub>	Bus free time between a STOP and START condition	1.3	-	-	μs
Сь	Capacitive load for each bus line	-	-	400	pF

STUSB4710 I<sup>2</sup>C interface

Figure 7: I<sup>2</sup>C timing diagram



I<sup>2</sup>C register map STUSB4710

# 6 I<sup>2</sup>C register map

Table 10: STUSB4710 register map overview

Address	Register name	Access	Description
00h to 0Ah	Reserved	RO	Do not use
0Bh	ALERT_STATUS	RC	Alert register linked to transition registers
0Ch	ALERT_STATUS_MASK_CTRL	R/W	Interrupt mask on ALERT_STATUS register
0Dh	CC_CONNECTION_STATUS_TRANS	RC	Alerts on transition in CC_CONNECTION_STATUS register
0Eh	CC_CONNECTION_STATUS	RO	CC connection status
0Fh	MONITORING_STATUS_TRANS	RC	Alerts on transition in MONITORING_STATUS register
10h	MONITORING_STATUS	RO	Gives status on V <sub>BUS</sub> voltage monitoring
11h	Reserved	RO	Do not use
12h	HW_FAULT_STATUS_TRANS	RC	Alerts on transition in HW_FAULT_STATUS register
13h	HW_FAULT_STATUS	RO	Hardware faults status
14h to 17h	Reserved	RO	Do not use
18h	CC_CAPABILITY_CTRL	R/W	Allows to change the CC capabilities
19h to 22h	Reserved	RO	Do not use
23h	RESET_CTRL	R/W	Controls the device reset by software
24h	Reserved	RO	Do not use
25h	VBUS_DISCHARGE_TIME_CTRL	R/W	Parameters defining V <sub>BUS</sub> discharge time
26h	VBUS_DISCHARGE_CTRL	R/W	Controls the V <sub>BUS</sub> discharge path
27h	VBUS_ENABLE_STATUS	RO	V <sub>BUS</sub> power path activation status
2Eh	VBUS_MONITORING_CTRL	R/W	Allows to change the monitoring conditions of V <sub>BUS</sub> voltage
19h to 1Eh	Reserved	RO	Do not use
71h	SRC_PDO1	R/W	PDO1 capabilities configuration
75h	SRC_PDO2	R/W	PDO2 capabilities configuration
79h	SRC_PDO3	R/W	PDO3 capabilities configuration
7Dh	SRC_PDO4	R/W	PDO4 capabilities configuration
81h	SRC_PDO5	R/W	PDO5 capabilities configuration
91h	SRC_RDO	RO	PDO request status

STUSB4710 I<sup>2</sup>C register map

Table 11: Register access legend

Access code Expanded name		Description
RO	Read only	Register can be read only
R/W	Read / Write	Register can be read or written
RC	Read and clear	Register can be read and is cleared after read

STUSB4710 Typical use cases

#### Typical use cases 7

#### Power supply – buck topology 7.1

Figure 8: Power supply - buck topology

The STUSB4710 offers the possibility to have up to 5 PDOs using (GPIO0 to GPIO3).

For example PDO1:5V 3A (no GPIO grounded), PDO2:9V 3A (GPIO0 to GND), PDO3:12V 3A (GPIO1 to GND), PDO4:15 volt (GPIO2 to GND), PDO5: 20 volt GPIO3 to GND)

PDO	Vout	Computation	Resistor value (ohm)
-	-	R1	200k
5	20	$R_2 = \frac{R_1 \cdot 1.22}{V_{OUT} - 1.22}$	13k
4	15	$R_3 = \frac{R_1 \cdot 1.22}{V_{OUT} - 1.22} - R_2$	4k7
3	12	$R_4 = \frac{R_1 \cdot 1.22}{V_{OUT} - 1.22} - R_2 - R_3$	4k87
2	9	$R_5 = \frac{R_1 \cdot 1.22}{V_{OUT} - 1.22} - R_2 - R_3 - R_4$	8k66
1	5	$R_6 = \frac{R_1 \cdot 1.22}{V_{OUT} - 1.22} - R_2 - R_3 - R_4 - R_5$	33k

Table 12: Resistor value

STUSB4710 Typical use cases

# 7.2 Power supply – fly-back topology

The STUSB4710 offers the possibility to have up to 5 PDOs using GPIO0 to GPIO3.

For example PDO1 (  $5\ V; 3\ A$ ) (no Sel\_PDO grounded), PDO2 (9  $V; 3\ A$ ) (GPIO0 to GND), PDO3 (15  $V; 3\ A$ ) (GPIO1 to GND).

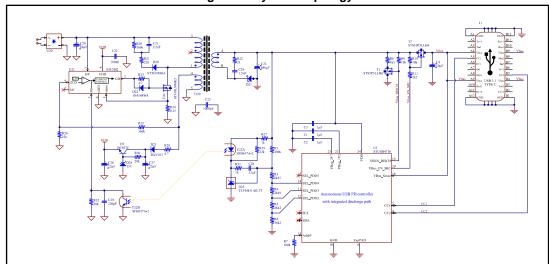


Figure 9: Fly-back topology

Table 13: Resistor value

PDO	V <sub>OUT</sub>	Computation	Resistor value (Ω)
-	-	R1	100k
4	15	$R_3 = \frac{R_1 \cdot 1.24}{V_{OUT} - 1.24}$	8k87
3	12	$R_4 = \frac{R_1 \cdot 1.24}{V_{OUT} - 1.24} - R_3$	2k49
2	9	$R_5 = \frac{R_1 \cdot 1.24}{V_{OUT} - 1.24} - R_3 - R_4$	4k42
1	5	$R_6 = \frac{R_1 \cdot 1.22}{V_{OUT} - 1.22} - R_2 - R_3 - R_4 - R_5$	16k2

Electrical characteristics STUSB4710

### 8 Electrical characteristics

## 8.1 Absolute maximum rating

All voltages are referenced to GND.

**Table 14: Absolute maximum rating** 

Symbol	Parameter	Value	Unit
V <sub>DD</sub>	Supply voltage	28	V
V <sub>CC1</sub> , V <sub>CC2</sub>	High voltage on CC pins	22	V
VVBUS_EN_SRC VVBUS_SENSE VVBUS_DISCH	High voltage on V <sub>BUS</sub> pins	28	>
VSCL, VSDA	Operating voltage on I/O pins	-0.3 to 6	V
T <sub>STG</sub>	Storage temperature	-55 to 150	°C
TJ	Maximum junction temperature	145	ပ္
ESD	НВМ	4	kV
ESD	CDM	1.5	ΚV

# 8.2 Operating conditions

**Table 15: Operating conditions** 

Symbol	Parameter	Value	Unit
$V_{DD}$	Supply voltage	4.1 to 22	V
VCC1, VCC2	CC pins (1)	-0.3 to 5.5	V
Vvbus_en_src Vvbus_sense Vvbus_disch	High voltage pins	0 to 22	V
VSCL, VSDA	Operating voltage on I/O pins	0 to 4.5	V
TA	Operating temperature	-40 to 105	°C

#### Notes:

# 8.3 Electrical and timing characteristics

Unless otherwise specified:  $V_{DD} = 5 \text{ V}$ ,  $T_A = +25 \,^{\circ}\text{C}$ , all voltages are referenced to GND.

**Table 16: Electrical characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
	_	Device Idle as SOURCE (not co	evice Idle as SOURCE (not connected, no communication)				
I <sub>DD(SRC)</sub>	Current consumption	V <sub>SYS</sub> @ 3.3 V	_	158	_	μA	
	Concumption	V <sub>DD</sub> @ 5.0 V	_	188	_	μA	



<sup>&</sup>lt;sup>(1)</sup>Transient voltage on CC1 and CC2 pins are allowed to go down to -0.3 during BMC communication from connected devices.

## STUSB4710 Electrical characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
	Standby	Device standby (not connected	l, low power)		1	<u> </u>
ISTDBY	current	V <sub>SYS</sub> @ 3.3 V	-	33	_	μΑ
	consumption	V <sub>DD</sub> @ 5.0 V	_	53	_	μA
CC1 and 0	CC2 pins		1		•	<u> </u>
I <sub>P-USB</sub>		CC pin voltage	-20%	80	+20%	μA
I <sub>P-1.5</sub>	CC current sources	$V_{CC} = -0.3 \text{ to } 2.6 \text{ V}$	-8%	180	+8%	μΑ
I <sub>P-3.0</sub>	30dices	-40° < T <sub>A</sub> < +105°	-8%	330	+8%	μA
Vcco	CC open pin voltage	CC unconnected, V <sub>DD</sub> =3.0 to 5.5 V	2.75	_	_	V
R <sub>d</sub>	CC pull-down resistors	-40° < T <sub>A</sub> < +105°	-10%	5.1	+10%	kΩ
		External I <sub>P</sub> =180 µA applied into CC	_	_	1.2	V
VCCDB-1.5 VCCDB-3.0	CC pin voltage in dead battery condition	External I <sub>P</sub> =330 µA applied into CC (V <sub>DD</sub> = 0, dead battery function enabled)	-	-	2	V
Rincc	CC input impedance	Pull-up and pull-down resistors off	200	-	_	kΩ
V <sub>TH0.2</sub>	Detection threshold 1	Max R <sub>a</sub> detection by DFP at I <sub>P</sub> = I <sub>P-USB</sub> , min I <sub>P_USB</sub> detection by UFP on R <sub>d</sub> , min CC voltage for connected UFP	0.15	0.2	0.25	V
V <sub>TH0.4</sub>	Detection threshold 2	Max $R_a$ detection by DFP at $I_P = I_{P-1.5}$	0.35	0.4	0.45	V
V <sub>TH0.66</sub>	Detection threshold 3	Min I <sub>P_1.5</sub> detection by UFP on R <sub>d</sub>	0.61	0.66	0.7	V
V <sub>TH0.8</sub>	Detection threshold 4	Max R <sub>a</sub> detection by DFP at I <sub>P</sub> = I <sub>P-3.0</sub>	0.75	0.8	0.85	V
V <sub>TH1.23</sub>	Detection threshold 5	Min $I_{P\_3.0}$ detection by UFP on $R_d$	1.16	1.23	1.31	V
V <sub>TH1.6</sub>	Detection threshold 6	Max R <sub>d</sub> detection by DFP at I <sub>P</sub> = I <sub>P-USB</sub> and I <sub>P</sub> = I <sub>P-1.5</sub>	1.5	1.6	1.65	V
V <sub>TH2.6</sub>	Detection threshold 7	Max R <sub>d</sub> detection by DFP at I <sub>P-3.0</sub> , max CC voltage for connected UFP	2.45	2.6	2.75	V
V <sub>BUS</sub> moni	toring and driving	•				<u> </u>
VTHUSB	V <sub>BUS</sub> presence threshold	V <sub>SYS</sub> =3.0 to 5.5 V	3.8	3.9	4	V
\/	V <sub>BUS</sub> safe 0V	V <sub>SYS</sub> =3.0 to 5.5 V	0.5	0.6	0.7	
V <sub>TH0</sub> V	threshold	Programmable threshold	0.8	0.9	1	V

### **Electrical characteristics**

### STUSB4710

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
	(vSafe0V)	(from 0.6 to 1.8 V)	1.1	1.2	1.3	
		Default V <sub>THOV</sub> = 0.6 V	1.7	1.8	1.9	
Rdisusb	V <sub>BUS</sub> discharge resistor		600	700	800	Ω
T <sub>DISUSB</sub>	V <sub>BUS</sub> discharge time to 0 V	Default T <sub>DISUSB</sub> = 840 ms . The coefficient T <sub>DISPARAM</sub> is programmable by NVM.	70 *T <sub>DISPA</sub> RAM	84 *T <sub>DISPA</sub> RAM	100 *T <sub>DISPA</sub> RAM	ms
		Default T <sub>DISUSB</sub> = 200 ms				
T <sub>DISUSB</sub>	V <sub>BUS</sub> discharge time to PDO	The coefficient T <sub>DISPARAM</sub> is programmable by NVM	20 *T <sub>DISPA</sub> RAM	24 *T <sub>DISPA</sub> RAM	28 *T <sub>DISPA</sub> RAM	ms
		V <sub>BUS</sub> = nominal target value				
VMONUSBH	V <sub>BUS</sub> monitoring	Default Vмонизвн = Vвиз +10%		V <sub>BUS</sub> +10%		V
VMONUSBH	high voltage threshold	The threshold limit is programmable by NVM from V <sub>BUS</sub> +5% to V <sub>BUS</sub> +20%	_	VBUS + 1076	_	V
		V <sub>BUS</sub> = nominal target value				
VMONUSBL	V <sub>BUS</sub> monitoring low voltage	Default V <sub>MONUSBL</sub> = V <sub>BUS</sub> - 10%		V <sub>BUS</sub> -10%		V
VMONOSBL	threshold	The threshold limit is programmable by NVM from V <sub>BUS</sub> -20% to V <sub>BUS</sub> -5%	_	VBUS - 10 76	_	V
Digital inpo	ut/output (SCL, SDA)					I.
VIH	High level input voltage		1.2	-	-	٧
V <sub>IL</sub>	Low level input voltage		-	-	0.35	V
VoL	Low level output voltage	loh = 3 mA	-	-	0.4	٧
20 V open	drain outputs (VBUS	_EN_SRC)				
VoL	Low level output voltage	loh = 3 mA	_	_	0.4	٧

# 9 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

## 9.1 QFN24 EP 4x4 mm package information

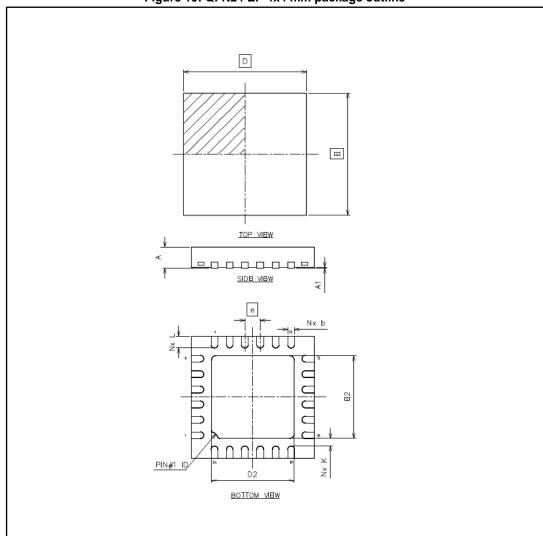
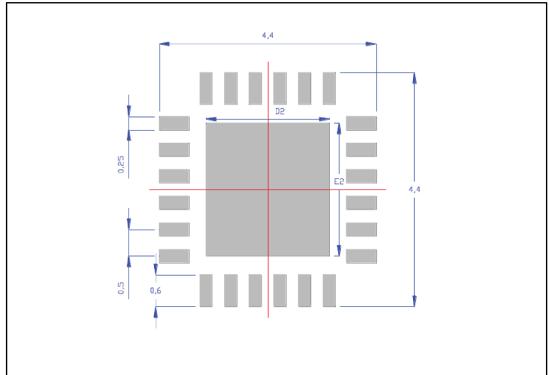


Figure 10: QFN24 EP 4x4 mm package outline

Table 17: QFN24 EP 4x4 mm mechanical data

Cumbal	Millimeters				
Symbol	Min	Тур	Max		
A	0.80	0.90	1.00		
A1	0.00	0.02	0.05		
b	0.18	0.25	0.30		
D	3.95	4.00	4.05		
D2	2.55	2.70	2.80		
E	3.95	4.00	4.05		
E2	2.55	2.70	2.80		
е	0.45	0.50	0.55		
K	0.15				
L	0.30	0.40	0.50		

Figure 11: QFN24 EP 4x4 mm recommended footprint



# 9.2 QFN16 package information

Figure 12: QFN16 package outline

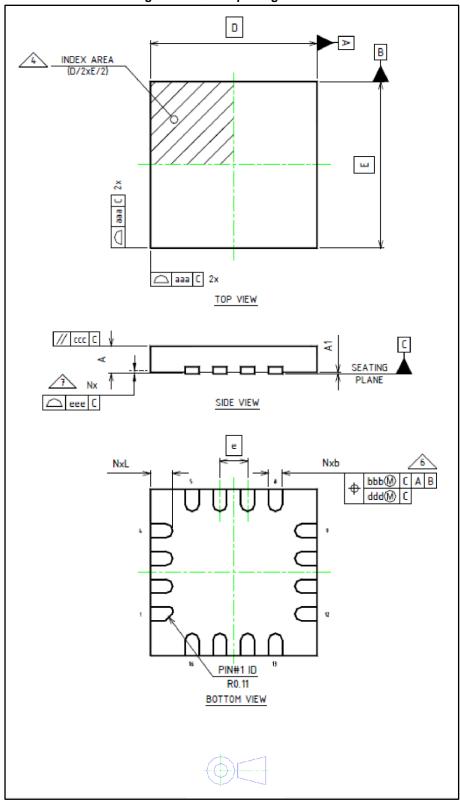


Table 18: QFN16 (3x3x0.55) mechanical data

Milimeters			
Symbol	Min	Тур	Max
А	0.5		0.65
A1	0		0.05
b	0.18	0.25	0.30
D	align="center"3.00 B	SC	
E		3.00 BSC	
е		0.50	
L		SEE VARIATIONS	
aaa			0.15
bbb			0.10
ccc			0.10
ddd			0.05
eee			0.08
n		16	
nD		4	
nE		4	
		L	
OPTION 1	0.30		0.50
OPTION 2	0.40		0.60

# 9.3 SO-16 package information

Figure 13: SO-16 package outline

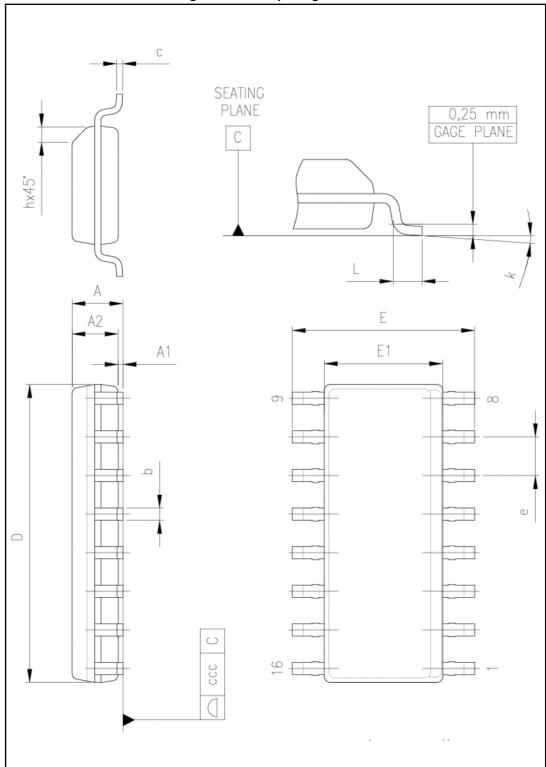


Table 19: SO-16 mechanical data

Symbol	Milimeters		
	Min	Тур	Max
А			1.75
A1	0.10		0.25
A2	1.25		
b	0.31		0.51
С	0.17		0.25
D	9.80	9.90	10.00
Е		6.00	6.20
E1		3.90	4.00
е		1.27	
h			0.50
L			1.27
k			8
ccc			0.10

# 9.4 Thermal information

**Table 20: Thermal information** 

Package	Symbol	Parameter	Value	Unit
OFN24 FD	R <sub>0JA</sub>	Junction-to-ambient thermal resistance	37	
QFN24 EP	R <sub>eJC</sub>	Junction-to-case thermal resistance	5	
QFN16	RθJA	Junction-to-ambient thermal resistance	78	°C/W
	Rejc	Junction-to-case thermal resistance	30	
SO-16	R <sub>θJA</sub>	Junction-to-ambient thermal resistance	95	

# 9.5 Packing information

Figure 14: Reel information

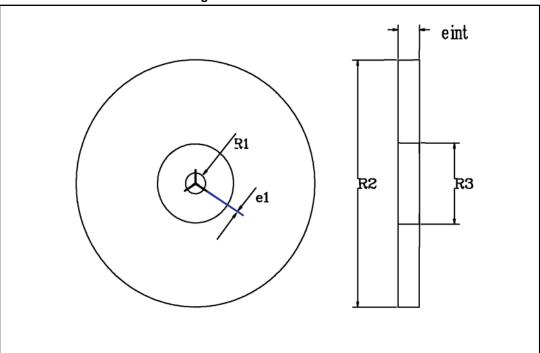


Table 21: Tape dimensions

Package	Pitch	Carrier width	Reel
QFN 4x4 - 24L	8 mm	12 mm	13"

Terms and abbreviations STUSB4710

## 10 Terms and abbreviations

Table 22: List of terms and abbreviations

Term	Description
Accessory modes	Audio adapter accessory mode. It is defined by the presence of Ra/Ra on the CC1/CC2 pins.
	Debug accessory mode. It is defined by the presence of Rd/Rd on CC1/CC2 pins in Source power role or Rp/Rp on CC1/CC2 pins in Sink power role.
DFP	Downstream Facing Port, associated with the flow of data in a USB connection. Typically, the ports on a HOST or the ports on a hub to which devices are connected. In its initial state, the DFP sources V <sub>BUS</sub> and V <sub>CONN</sub> and supports data.
DRP	Dual-role port. A port that can operate as either a source or a sink. The port's role may be changed dynamically.
Sink	Port asserting Rd on the CC pins and consuming power from the V <sub>BUS</sub> ; most commonly a device.
Source	Port asserting Rp on the CC pins and providing power over the $V_{\text{BUS}}$ ; usually a host or hub DFP.
UFP	Upstream Facing Port, specifically associated with the flow of data in a USB connection. The port on a device or a hub that connects to a host or the DFP of a hub. In its initial state, the UFP sinks the VBUS and supports data.

STUSB4710 Revision history

# 11 Revision history

**Table 23: Document revision history** 

Date	Version	Changes
05-Apr-2017	1	Initial release.
12-Jul-2017	2	Updated Features, Table 2: "Pin functions list", Section 2.3.10: "SEL_PDO [5:2]", Section 4.4: "Monitoring configuration in NVM", Section 4.5: "Discharge configuration in NVM", Section 5.1: "Read and write operations", Table 15: "Operating conditions ", Table 20: "Thermal information", and Section 7.2: "Power supply – flyback topology".

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